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PATENT APPLICATION

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re the Application of

Akihiro MURATA

Application No.: 09/245,288

Filed: February 5, 1999

For: SEMICONDUCTOR APPARATUS SUBSTRATE, SEMICONDUCTOR
APPARATUS, AND METHOD OF MANUFACTURING THEREOF



Group Art Unit: 2811

Examiner: M. Dietraich

Docket No.: 101937

AMENDMENT

Director of the U.S. Patent and Trademark Office
Washington, D. C. 20231

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DEC 27 2000
TECHNOLOGY CENTER 2800

Sir:

In reply to the Office Action mailed June 20, 2000, please amend the above-identified application as follows:

IN THE CLAIMS:

Please cancel claim 5.

Please amend claims 1, 7 and 19 as follows:

1. (Amended) A semiconductor apparatus, comprising:
- a substrate main body having a mounting surface for mounting the semiconductor device;
- a plurality of leads formed on the mounting surface, the plurality of leads radially extending from a peripheral area toward a central area of the substrate main body;
- and
- a plurality of conduction sections each defining at least part of an external terminal, [wherein] the conduction sections [are] being electrically connected to the leads.
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